



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wayne Glenn Renken  
Title: System and Method for Heating and Cooling Wafer at Accelerated Rates  
Application No.: 10/619,731 Filing Date: July 15, 2003  
Examiner: Unknown Group Art Unit: 1725  
Docket No.: SENS.007US1 Conf. No.: 7022

Certificate of Mailing Under 37 CFR 1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on October 28, 2003

Mary S. Buggin  
Signature

Mail Stop Missing Parts  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**REQUEST FOR CORRECTION OF FILING DATE  
AND CORRECTED FILING RECEIPT**

Dear Sir:

Applicant hereby requests the Commissioner For Patents to correct the Official Filing Date and to correct the Official Filing Receipt for the above-identified patent application as follows:

- ☒ 1. Correct the Filing Date
- ☐ 2. Correct Inventor Name
- ☐ 3. Correct Title
- ☐ 4. Correct information referencing related case
- ☐ 5. Correct Attorney Docket Number
- ☐ 6. Other: \_\_\_\_\_

Attorney Docket No.: SENS.007US1

Application No.: 10/619,731

This Request is submitted for the following reasons:

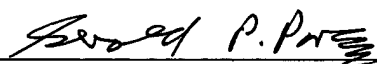
The application has been assigned an incorrect Filing Date. The Filing Date should be July 15, 2003. The Official Filing Receipt presently reflects the Filing Date as July 14, 2003.

Because this was not an error on the part of the Applicant, Applicant believes no fee is required.

Attached is a copy of the Filing Receipt having the above error and the change noted thereon, as well as a copy of the Application Transmittal Letter, Express Mail Receipt and return receipt postcard, all of which show that the application was filed on July 15, 2003. Therefore, it is respectfully requested that the Filing Date be corrected and a corrected Filing Receipt be issued.

If this action does not lead to issuance of a corrected Official Filing Receipt as requested, please contact the undersigned at (415) 318-1160.

Respectfully submitted,

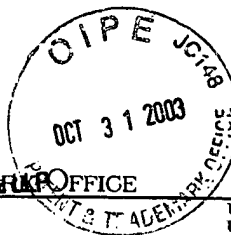
  
\_\_\_\_\_  
Gerald P. Parsons  
Attorney for Applicant  
Reg. No. 24,486

\_\_\_\_\_  
October 28, 2003  
Date

PARSONS HSUE & DE RUNTZ LLP  
655 Montgomery Street, Suite 1800  
San Francisco, CA 94111  
(415) 318-1160 (main)  
(415) 318-1163 (direct)  
(415) 693-0194 (fax)

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OCT 13 2003



## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
 United States Patent and Trademark Office  
 Address: COMMISSIONER FOR PATENTS  
 P.O. Box 1450  
 Alexandria, Virginia 22313-1450  
 www.uspto.gov

APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/619,731	<del>07/14/2003</del> 07/15/2003	1725	624	SENS.007US1	5	29	7

PARSONS HSUE & DE RUNTZ LLP  
 SUITE 1800  
 655 MONTGOMERY STREET  
 SAN FRANCISCO, CA 94111

CONFIRMATION NO. 7022

## FILING RECEIPT



\*OC000000011021557\*

Date Mailed: 10/10/2003

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

Wayne Glenn Renken, Residence Not Provided;

ATTORNEY: GEP / GEP

PRIORITY

ACTION: /

ACTION: /

## Domestic Priority data as claimed by applicant

This application is a CIP of 10/100,934 03/18/2002 DOCKETED

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10-13-03

## Foreign Applications

VERIFICATION

If Required, Foreign Filing License Granted: 10/09/2003

Projected Publication Date: To Be Determined - pending completion of Missing Parts

Non-Publication Request: No

Early Publication Request: No

\*\* SMALL ENTITY \*\*

## Title

System and method for heating and cooling wafer at accelerated rates

## Preliminary Class

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**LICENSE FOR FOREIGN FILING UNDER  
Title 35, United States Code, Section 184  
Title 37, Code of Federal Regulations, 5.11 & 5.15**

**GRANTED**

The applicant has been granted a license under 35 U.S.C. 184, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" followed by a date appears on this form. Such licenses are issued in all applications where the conditions for issuance of a license have been met, regardless of whether or not a license may be required as set forth in 37 CFR 5.15. The scope and limitations of this license are set forth in 37 CFR 5.15(a) unless an earlier license has been issued under 37 CFR 5.15(b). The license is subject to revocation upon written notification. The date indicated is the effective date of the license, unless an earlier license of similar scope has been granted under 37 CFR 5.13 or 5.14.

This license is to be retained by the licensee and may be used at any time on or after the effective date thereof unless it is revoked. This license is automatically transferred to any related applications(s) filed under 37 CFR 1.53(d). This license is not retroactive.

The grant of a license does not in any way lessen the responsibility of a licensee for the security of the subject matter as imposed by any Government contract or the provisions of existing laws relating to espionage and the national security or the export of technical data. Licensees should apprise themselves of current regulations especially with respect to certain countries, of other agencies, particularly the Office of Defense Trade Controls, Department of State (with respect to Arms, Munitions and Implements of War (22 CFR 121-128)); the Office of Export Administration, Department of Commerce (15 CFR 370.10 (j)); the Office of Foreign Assets Control, Department of Treasury (31 CFR Parts 500+) and the Department of Energy.

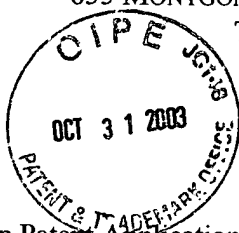
**NOT GRANTED**

No license under 35 U.S.C. 184 has been granted at this time, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" DOES NOT appear on this form. Applicant may still petition for a license under 37 CFR 5.12, if a license is desired before the expiration of 6 months from the filing date of the application. If 6 months has lapsed from the filing date of this application and the licensee has not received any indication of a secrecy order under 35 U.S.C. 181, the licensee may foreign file the application pursuant to 37 CFR 5.15(b).

**COPY****PARSONS HSUE & DE RUNTZ LLP**

655 MONTGOMERY STREET, SUITE 1800 ♦ SAN FRANCISCO, CALIFORNIA 94111

TELEPHONE: (415) 318-1160 ♦ FAX: (415) 693-0194



Docket No.: SENS.007US1

July 15, 2003

Mail Stop Patent Application

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Enclosed herewith for filing is a patent application, as follows:

Inventor: Wayne Glenn Renken

Title: System and Method for Heating and Cooling Wafer at Accelerated Rates

- X Check in the amount of \$624.00
- X Return Receipt Postcard
- X This Transmittal Letter (in duplicate)
- 12 pages Specification (not including claims)
- 5 pages Claims
- 1 page Abstract
- 5 Sheets of Formal Drawings

Other:

**Applicant asserts entitlement to small entity status for the attached patent application****CLAIMS AS FILED**

<u>For</u>	<u>Number</u>			<u>Number</u>		<u>Rate</u>		<u>Basic Fee</u>
	<u>Filed</u>			<u>Extra</u>				
Total Claims	29	-20	=	9	x	\$9.00	=	\$ 81.00
Independent Claims	7	-3	=	4	x	\$42.00	=	\$ 168.00
<input type="checkbox"/>	Fee of _____ for the first filing of one or more multiple dependent claims per application							\$ 0.00
<input type="checkbox"/>	Fee for Assignment Recordation							\$ 0.00
<input checked="" type="checkbox"/>	Total fee for filing the patent application in the amount of							\$ <u>624.00</u>
<input checked="" type="checkbox"/>	The Commissioner is hereby authorized to charge any additional fees, which may be required, or credit any overpayment to Deposit Account 502664.							

EXPRESS MAIL LABEL NO:

EU962645425US

Respectfully submitted,

Gerald P. Parsons  
Attorney for Applicant  
Reg. No. 24,486





**COPY**

MAIL STOP PATENT APPLICATION  
COMMISSIONER FOR PATENTS  
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ALEXANDRIA, VA 22313-1450

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BY DOCKET DEPT.

JUL 23 2003

Applicant: Wayne Glenn Renken  
Assignee: SensArray Corporation  
Title: System and Method for heating and Cooling Wafer at Accelerated Rates  
Atty Docket No.: SENS.007US1

ENCLOSED:

1. This Return Receipt Postcard
2. Transmittal Letter (1 page - in duplicate)
3. Specification (12 pages), Claims (5 pages) and Abstract (1 page)
4. Formal Drawings (5 sheets)
5. Check for \$624.00

GPP/meb

Express Mail Label No.: EU962645425US

Due Date: N/A  
Mailing Date: July 15, 2003

*GPP/GPP*

